

## Extended InGaAs Photodiodes IG26-Series

### Description

The IG26-series is a panchromatic PIN photodiode with a nominal cut-off wavelength at 2.6  $\mu\text{m}$ . This series has been designed for demanding spectroscopic and radiometric applications. It offers excellent shunt resistance in combination with superior responsivity over a wide spectral range.

### Features

- 50 % cut-off wavelength > 2.45  $\mu\text{m}$
- Typical peak responsivity: 1.45 A/W
- Excellent temperature stability
- Reduced edge effect

### Applications

- Spectrophotometer
- Diode laser monitoring
- Non-contact temperature measurement
- Flame control
- Moisture monitoring

### Versions

- Uncooled:  
TO-can, chip only
- Cooled:  
TE1, TE2, TE3



Optical Characteristics, Specifications @ 25 °C <sup>c</sup>

Part Number	Diameter [μm]	50% Cut off Wavelength <sup>a</sup> [μm]	Peak Wavelength <sup>a</sup> [μm]	Peak Responsivity <sup>a,b</sup> [A/W]		Responsivity @ 520 nm <sup>a,b,d</sup> [A/W]		Responsivity @ 1600 nm <sup>a,b</sup> [A/W]		Responsivity @ 1900 nm <sup>a,b</sup> [A/W]	
			Typ.	Min.	Typ.	Min.	Typ.	Min.	Typ.	Min.	Typ.
IG26X250S4i	250	≥2.45	2.25+/- 0.1	1.30	1.50	TBD	0.1	0.7	1.0	1.08	1.36
IG26X500S4i	500										
IG26X1000S4i	1000										
IG26X1300S4i	1300										
IG26X2000G1i	2000										
IG26X3000G1i	3000										

<sup>a</sup> Parameter tested on batch level at T =25°C.

<sup>b</sup> Responsivity measured at 0 V Bias.

<sup>c</sup> Data are prior to window integration.

<sup>d</sup> Preliminary data

## Electro-Optical Characteristics, Specifications @ 25 °C

Part Number	Diameter [μm]	Shunt Impedance @ V <sub>r</sub> = 10 mV <sup>b</sup> [kOhm]		Dark Current @ V <sub>r</sub> = 0.25 V <sup>b</sup> [μA]		Peak D* <sup>a</sup> f = 1 kHz [cm Hz <sup>1/2</sup> /W]		Peak NEP <sup>a</sup> f = 1 kHz [W/Hz <sup>1/2</sup> ]	
		Min.	Typ.	Typ.	Max.	Min.	Typ.	Max.	Typ.
IG26X250S4i	250	25	60	2	8	8.3 E+10	1.2 E+11	6.0 E-13	4.2 E-13
IG26X500S4i	500	10	25	4	25	7.4 E+10	1.2 E+11	1.0 E-12	6.0 E-13
IG26X1000S4i	1000	3	9	8	75	5.7 E+10	1.0 E+11	1.8 E-12	1.0 E-12
IG26X1300S4i	1300	1	4	15	150	3.7 E+10	7.6 E+10	3.0 E-12	1.5 E-12
IG26X2000G1i	2000	0.6	1.5	30	300	3.6 E+10	5.8 E+10	3.9 E-12	2.4 E-12
IG26X3000G1i	3000	0.25	0.7	75	750	2.8 E+10	4.8 E+10	6.0 E-12	3.6 E-12

<sup>a</sup> Parameter tested on batch level

<sup>b</sup> Parameter 100% tested

### Electrical Characteristics, Specifications @ 25 °C

Part Number	Diameter [ $\mu\text{m}$ ]	Capacitance @ $V_r = 0 \text{ V}^a$ [pF]	Forward Voltage [V]
		Typ.	Typ.
IG26X250S4i	250	35	0.48
IG26X500S4i	500	140	
IG26X1000S4i	1000	580	
IG26X1300S4i	1300	1040	
IG26X2000G1i	2000	1920	
IG26X3000G1i	3000	3200	

<sup>a</sup> Parameter tested on batch level

### Thermoelectrically Cooled InGaAs Detectors

Part Number	Diameter [ $\mu\text{m}$ ]	Operating Temperature [°C]	Shunt Impedance @ $V_r = 10 \text{ mV}^b$ [kOhm]		Peak $D^*^a$ [ $\text{cm Hz}^{1/2}/\text{W}$ ]	Peak NEP <sup>a</sup> [ $\text{W}/\text{Hz}^{1/2}$ ]	Capacitance @ $V_r = 0 \text{ V}^a$ [pF]
			Min.	Typ.	Typ.	Typ.	Typ.
IG26X250T7	250	-10	-	-	-	-	35
IG26X1000T7	1000		15	75	3.9 E+11	3.5 E-13	580
IG26X1300T7	1300		-	-	-	-	1040
IG26X2000T7	2000		3	15	1.8 E+11	7.8 E-13	1925
IG26X3000T7	3000		-	-	-	-	3200
IG26X250T9	250	-20	-	-	-	-	35
IG26X1000T9	1000		30	150	4.1 E+11	2.5 E-13	580
IG26X1300T9	1300		-	-	-	-	1040
IG26X2000T9	2000		6	30	2.6 E+11	5.5 E-13	1920
IG26X3000T9	3000		-	-	-	-	3200

<sup>a</sup> Parameter tested on batch level

<sup>b</sup> Parameter 100% tested

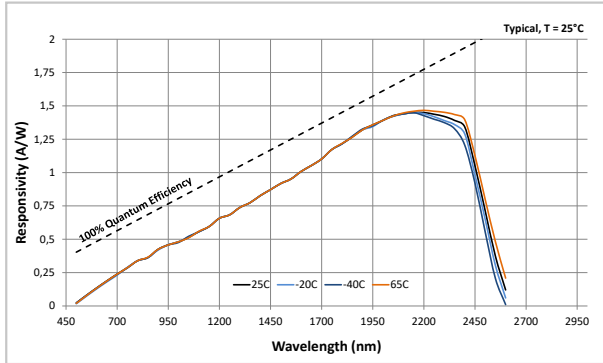
## Absolute Maximum Ratings

		Min.	Max.
Storage temperature [°C]		-55	+125
Operating temperature [°C]		-40	+85
Reverse bias, cw [V]		-	1
Forward current, cw [mA]		-	1
Soldering temperature, 5 sec. [°C]		-	260
ESD damage threshold, human body model class 0*, [V]		0	<250
TE cooler voltage [V]	T7	-	0.8
	T9	-	3.7
TE cooler current [A]	T7	-	1.9
	T9	-	1.2

\*ANSI/ ESD STN5. 1-2007

Valid with sufficient heat sinking only.

Fig. 1: Spectral Response



Spectral Response Zoom

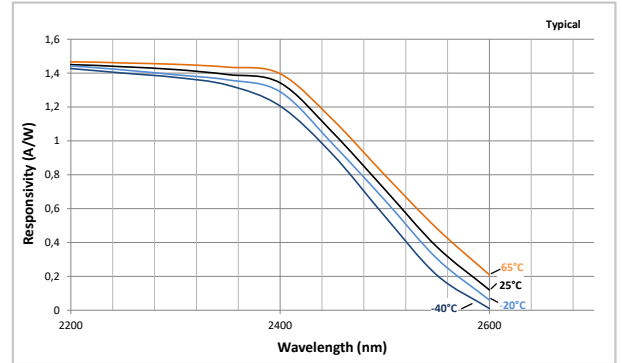


Fig. 2: Dark Current vs. Reverse Voltage

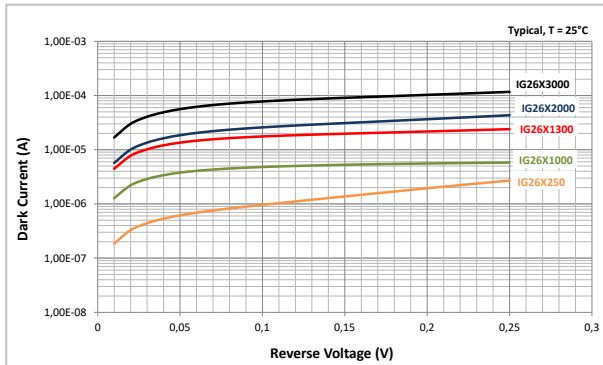


Fig. 3: Shunt Resistance vs. Temperature

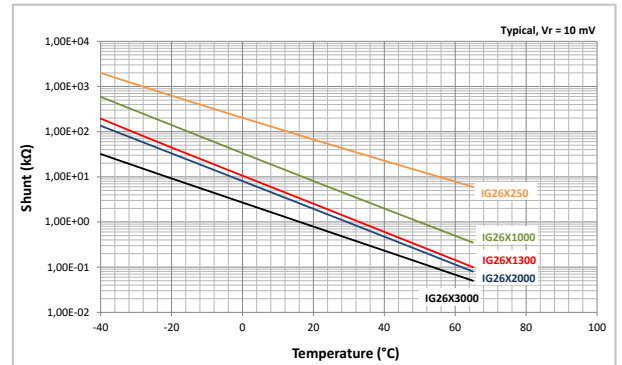


Fig. 4: Shunt Resistance vs. Detectivity

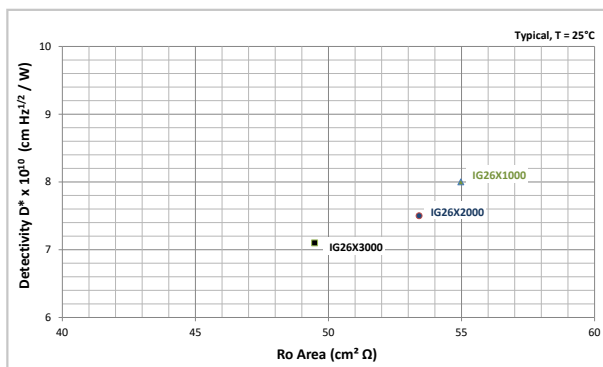


Fig. 5: Capacitance vs. Reverse Voltage

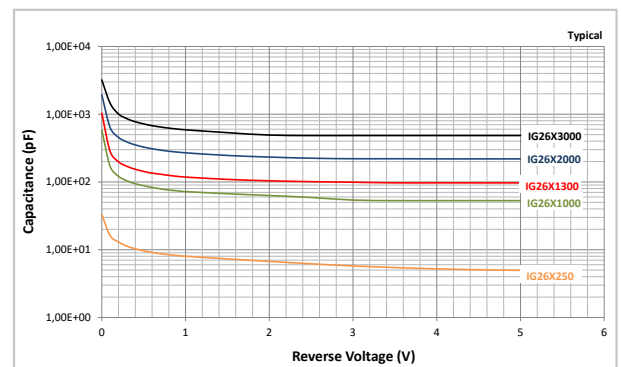


Fig. 6: Responsivity Temperature Coefficient I

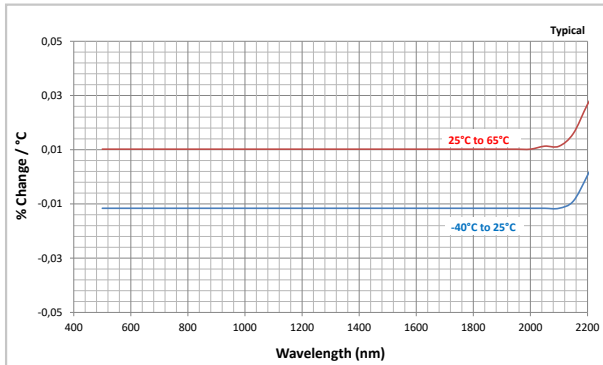


Fig. 7: Responsivity Temperature Coefficient II

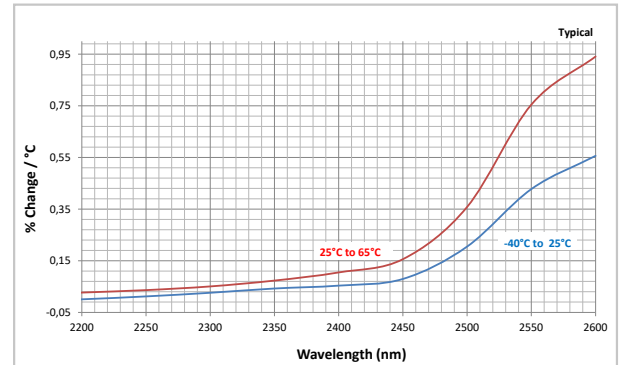


Fig. 8: Sample Pulse Response

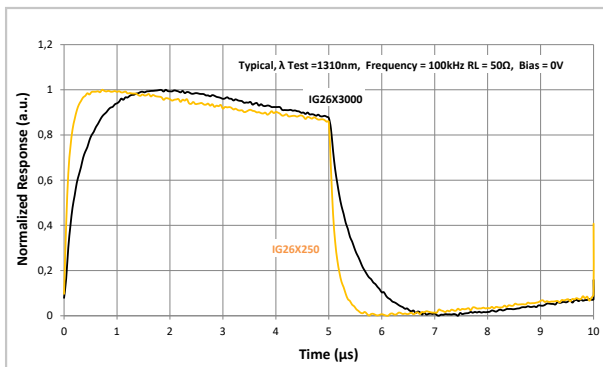
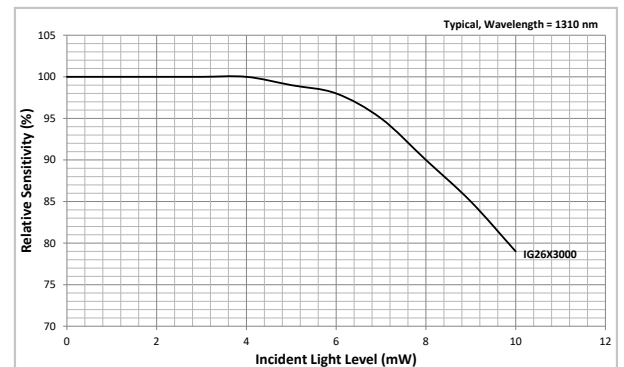


Fig. 9: Linearity



## Nomenclature

<b>C-</b>	<b>I</b>	<b>G</b>	<b>2</b>	<b>6</b>	<b>X</b>		<b>2</b>	<b>5</b>	<b>0</b>	<b>S</b>	<b>4</b>	<b>i</b>	
Chip only	Type					Diameter				Package Style			
	Extended InGaAs PIN Photodiode					250 = 250 µm				S4i - TO-46, isolated			
						500 = 500 µm				S4ix - TO-46, no window			
						1000 = 1 mm				G1i - TO-39, isolated			
						1300 = 1.3 mm				G1ix - TO-39, no window			
						2000 = 2 mm				T7 - TO-37, single stage TEC			
						3000 = 3 mm				T9 - TO-66, dual stage TEC			
										L5 - TO-46 lens cap			

Standard window: Borosilicate glass

Package drawings, TEC and thermistor curves can be found on a separate datasheet.

## Product Changes

LASER COMPONENTS reserves the right to make changes to the product(s) or information contained herein without notice. No liability is assumed as a result of their use or application.

## Ordering Information

Products can be ordered directly from LASER COMPONENTS or its representatives. For a complete listing of representatives, visit our website at [www.lasercomponents.com](http://www.lasercomponents.com)